

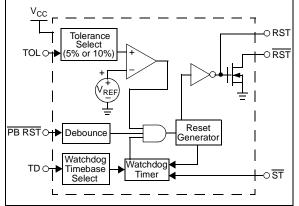
TC1232

Microprocessor Monitor

Features

- Precision Voltage Monitor
- Adjustable +4.5V or +4.75V
- Reset Pulse Width 250 msec minimum
- No External Components
- Adjustable Watchdog Timer
- 150 msec, 600 msec or 1.2 sec
- Operating Voltage 4.0V to 5.5V
- Debounced Manual Reset Input for External Override

Block Diagram



General Description

The TC1232 is a fully-integrated processor supervisor that provides three important functions to safeguard processor sanity: precision power on/off reset control, watchdog timer and external reset override.

On power-up, the TC1232 holds the processor in the reset state for a minimum of 250 msec after V_{CC} is within tolerance to ensure a stable system start-up.

Microprocessor sanity is monitored by the onboard watchdog circuit. The microprocessor must provide a periodic low-going signal on the \overline{ST} input. Should the processor fail to supply this signal within the selected time-out period (150 msec, 600 msec or 1200 msec), an out-of-control processor is indicated and the TC1232 issues a processor reset as a result.

The outputs of the TC1232 are immediately driven active when the PB input is brought low by an external push button switch or other electronic signal. When connected to a push button switch, the TC1232 provides contact debounce.

The TC1232 is packaged in a space-saving 8-Pin PDIP or SOIC package, a 16-Pin SOIC (wide) package and requires no external components.

Package Types

8-Pin PDIP	8-Pin SOIC	16-Pin SOIC (Wide)
PB RST 1 TD 2 TOL 3 GND 4 TC1232 8 V _{CC} 7 ST 7 ST 6 RST 5 RST	PB RST 1 TD 2 TOL 3 GND 4 FC1232 8 Vcc 7 ST 6 RST	NC [1] 16 NC PB RST [2] 15 VCC NC [3] 14 NC TD [4] 13 ST NC [5] 12 NC TOL [6] 11 RST NC [7] 10 NC GND [8] 9 RST

Device Features

	R	RST pin			RST pin		Minimum	WDI Input	
Device	Туре	Pull-up Resistor	Active Level	Туре	Active Level	Trip Points (Max)	Reset Active Time (ms)	Typical Timeouts (ms)	MR Input
TC1232	Open-drain	External	Low	Push-pull	High	4.75V or 4.5V	250	150, 600 or 1200	Yes

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1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Voltage on Any Pin (With Respect to GND)-0.3V to +5.8V

Operating Temperature Range:

C-Version	0°C to +70°C
E-Version	40°C to +85°C
Storage Temperature Range:	65°C to +150°C

† Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions above those indicated in the operation sections of the specifications is not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS

Parameters	Sym	Min	Typ	Max	Units	Conditions
Falameters	Sym		Тур	IVIAA	Units	Conditions
Supply Voltage	V _{CC}	4.0	5.0	5.5	V	
ST and PB RST Input High Level	VIH	2.0	-	V _{CC} +0.3	V	Note 1
ST and PB RST Input Low Level	V _{IL}	-0.3		+0.8	V	
Input Leakage ST, TOL	١L	-1.0		+1.0	μA	
Output Current RST	I _{OH}	-1.0	-12		mA	V _{OH} = 2.4V
Current RST, RST	I _{OL}	2.0	10	_	mA	$V_{OL} = 0.4V$
Operating Current	I _{CC}		50	200	μA	Note 2
V _{CC} 5% Trip Point	V _{CCTP}	4.50	4.62	4.74	V	TOL = GND (Note 3)
V _{CC} 10% Trip Point	V _{CCTP}	4.25	4.37	4.49	V	TOL = V _{CC} (Note 3)
Capacitance Electrical Characte	eristics: U	Inless oth	nerwise r	noted, $T_A =$	+25°C.	(Note 4)
Input Capacitance ST, TOL	C _{IN}	_	_	5	pF	
Output Capacitance RST, RST	C _{OUT}	_	_	7	pF	

Note 1: $\overline{PB RST}$ is internally pulled up to V_{CC} with an internal impedance of typically 40 k Ω .

2: Measured with outputs open.

3: All voltages referenced to GND.

4: Ensured by design.

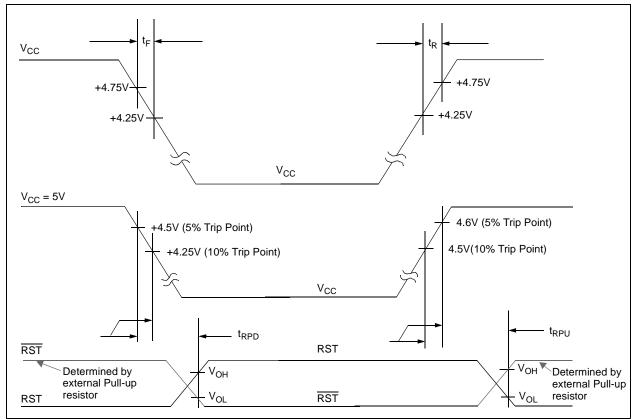


FIGURE 1-1: Rise Time, Fall Time and Reset Detected to Reset Active Timing Waveforms.

AC CHARACTERISTICS

Electrical Specifications: Unless otherwise noted, $T_A = T_{MIN}$ to T_{MAX} ; $V_{CC} = +4.0V$ to 5.5V.								
Parameters	Sym	Min	Тур	Max	Units	Conditions		
V _{CC} Fall Time	t _F	10	—	_	μs	Note 1		
V _{CC} Rise Time	t _R	0	—	_	μs	Note 1		
V _{CC} Trip Point Detected to RST High and RST Low	t _{RPD}	_	—	100	ns	V _{CC} falling		
V _{CC} Trip Point Detected to RST High and RST Open	t _{RPU}	250	610	1000	ms	V _{CC} rising (Note 2)		

Note 1: Ensured by design.

2: $t_R = 5 \ \mu s$.

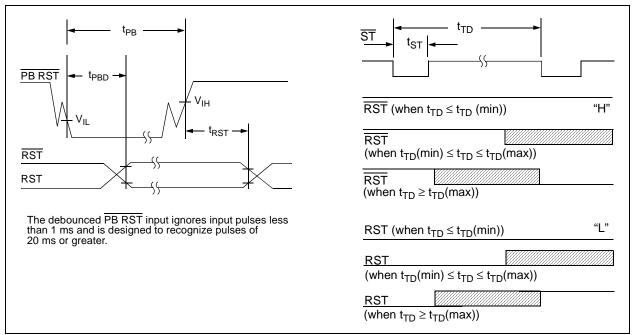


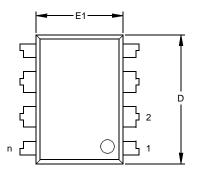
FIGURE 1-2: Push Button Reset and Watchdog Timer Reset Timing Waveforms.

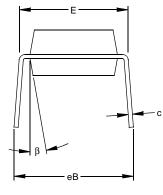
AC CHARACTERISTICS (CONTINUED)

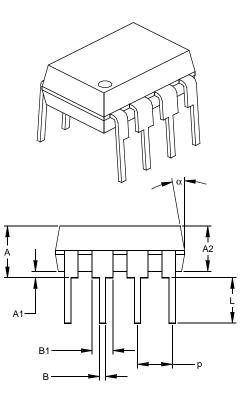
Electrical Specifications: Unless otherwise noted, $T_A = T_{MIN}$ to T_{MAX} ; $V_{CC} = +4.0V$ to 5.5V.								
Parameters	Sym	Min	Тур	Max	Units	Conditions		
PB RST Pulse Width	t _{PB}	20	—		ms	Note 1		
PB RST Falling Edge Low to Reset Active	t _{PBD}	1	4	20	ms			
PB RST Rising Edge High to Reset Inactive	t _{RST}	250	610	1000	ms			
ST Pulse Width	t _{ST}	20	_		ns			
ST Time-out Period	t _{TD}	62.5	150	250	ms	TD Pin = 0V		
		250	600	1000	ms	TD Pin = Open		
		500	1200	2000	ms	TD Pin = V _{CC}		

Note 1: PB RST must be held low for a minimum of 20 ms to ensure a reset.

8-Lead Plastic Dual In-line (PA) – 300 mil (PDIP)







	Units		INCHES*		M	IILLIMETERS	
Dimens	ion Limits	MIN	NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	р		.100			2.54	
Top to Seating Plane	Α	.140	.155	.170	3.56	3.94	4.32
Molded Package Thickness	A2	.115	.130	.145	2.92	3.30	3.68
Base to Seating Plane	A1	.015			0.38		
Shoulder to Shoulder Width	E	.300	.313	.325	7.62	7.94	8.26
Molded Package Width	E1	.240	.250	.260	6.10	6.35	6.60
Overall Length	D	.360	.373	.385	9.14	9.46	9.78
Tip to Seating Plane	L	.125	.130	.135	3.18	3.30	3.43
Lead Thickness	С	.008	.012	.015	0.20	0.29	0.38
Upper Lead Width	B1	.045	.058	.070	1.14	1.46	1.78
Lower Lead Width	В	.014	.018	.022	0.36	0.46	0.56
Overall Row Spacing	§ eB	.310	.370	.430	7.87	9.40	10.92
Mold Draft Angle Top	α	5	10	15	5	10	15
Mold Draft Angle Bottom	β	5	10	15	5	10	15

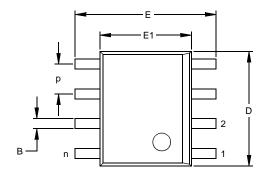
* Controlling Parameter § Significant Characteristic

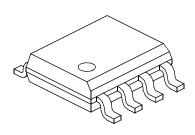
Notes:

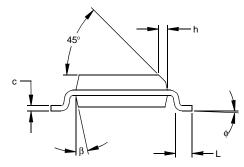
Notes: Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MS-001 Drawing No. C04-018

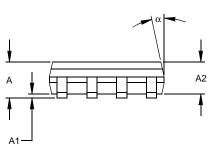
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8-Lead Plastic Small Outline (OA) – Narrow, 150 mil (SOIC)









	Units		INCHES*		MILLIMETERS		
Dimen	Dimension Limits		NOM	MAX	MIN	NOM	MAX
Number of Pins	n		8			8	
Pitch	р		.050			1.27	
Overall Height	Α	.053	.061	.069	1.35	1.55	1.75
Molded Package Thickness	A2	.052	.056	.061	1.32	1.42	1.55
Standoff §	A1	.004	.007	.010	0.10	0.18	0.25
Overall Width	E	.228	.237	.244	5.79	6.02	6.20
Molded Package Width	E1	.146	.154	.157	3.71	3.91	3.99
Overall Length	D	.189	.193	.197	4.80	4.90	5.00
Chamfer Distance	h	.010	.015	.020	0.25	0.38	0.51
Foot Length	L	.019	.025	.030	0.48	0.62	0.76
Foot Angle	¢	0	4	8	0	4	8
Lead Thickness	С	.008	.009	.010	0.20	0.23	0.25
Lead Width	В	.013	.017	.020	0.33	0.42	0.51
Mold Draft Angle Top	α	0	12	15	0	12	15
Mold Draft Angle Bottom	β	0	12	15	0	12	15
° '		-		-			

* Controlling Parameter § Significant Characteristic

Notes:

Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed .010" (0.254mm) per side. JEDEC Equivalent: MS-012 Drawing No. C04-057

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office.

	X /XX erature Package nge	b) TC1232COA713:	0°C to +70°C, 8L-SOIC 0°C to +70°C, 8L-SOIC, Tape and Reel
Device:	TC1232: Microprocessor Monitor	c) TC1232COE: d) TC1232COE713:	0°C to +70°C, 16L-SOIC 0°C to +70°C, 16L-SOIC Tape and Reel
Temperature Range:	$C = 0^{\circ}C \text{ to } +70^{\circ}C$ E = -40^{\circ}C to +85^{\circ}C	e) TC1232CPA: f) TC1232EOA:	0°C to +70°C, 8L-PDIP -40°C to +85°C, 8L-SOIC
Package:	PA = Plastic DIP (300 mil Body), 8-lead OA = Plastic SOIC, (150 mil Body), 8-lead OA713 = Plastic SOIC, (150 mil Body), 8-lead	g) TC1232EOA713:	-40°C to +85°C, 8L-SOIC, Tape and Reel
	Tape and Reel OE = Plastic SOIC (300 mil Body), 16-lead	h) TC1232EOE:	-40°C to +85°C, 16L-SOIC
	OE713 = Plastic SOIC (300 mil Body), 16-lead Tape and Reel	i) TC1232EOE713:	-40°C to +85°C, 16L-SOIC, Tape and Reel
		j) TC1232EPA:	-40°C to +85°C, 8L-PDIP

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